

IR SEMINAR 2021

ULVAC

ULVAC's Approach to the Chinese Electronic Device Market

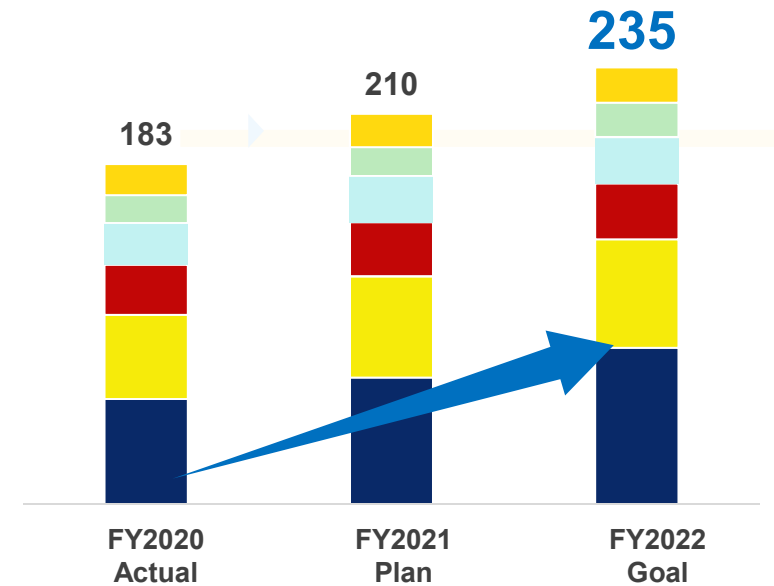
ULVAC (Shanghai) Trading Co., Ltd.
Director, Vice General Manager
Takaya Iwai

*Leading the World
In Vacuum Technology*

Dec.15,2021



Net Sales (Unit: ¥1 billion)



Electronics Device

Power/Optical/Communication Devices ·
Packaging · Sensor

Smaller size and lower cost

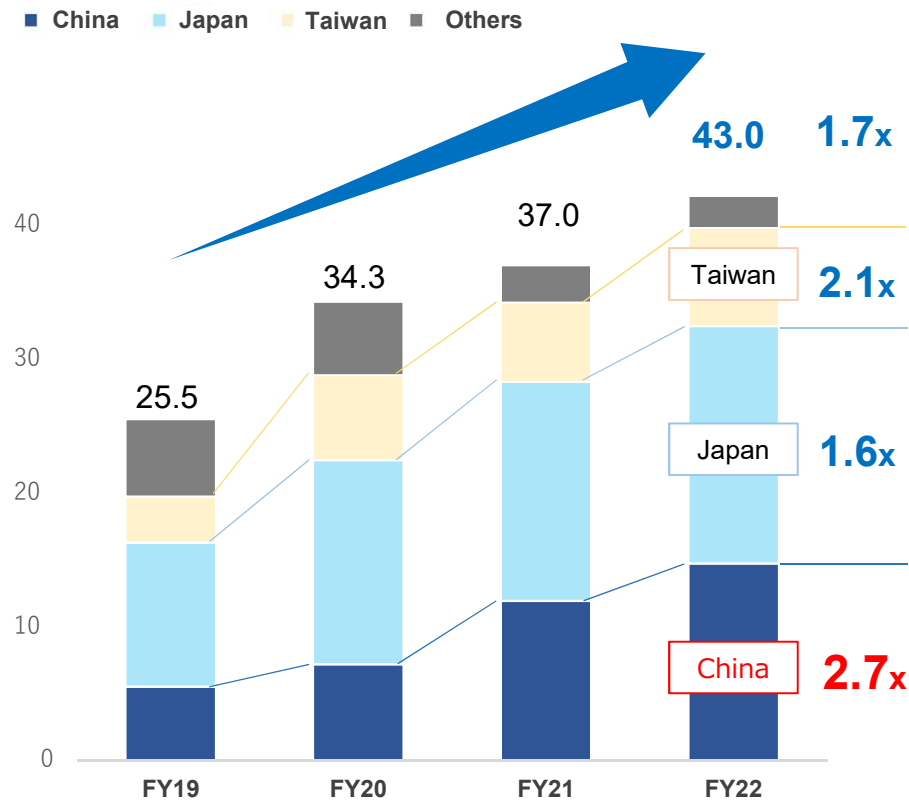
Lower energy consumption

High speed and low latency

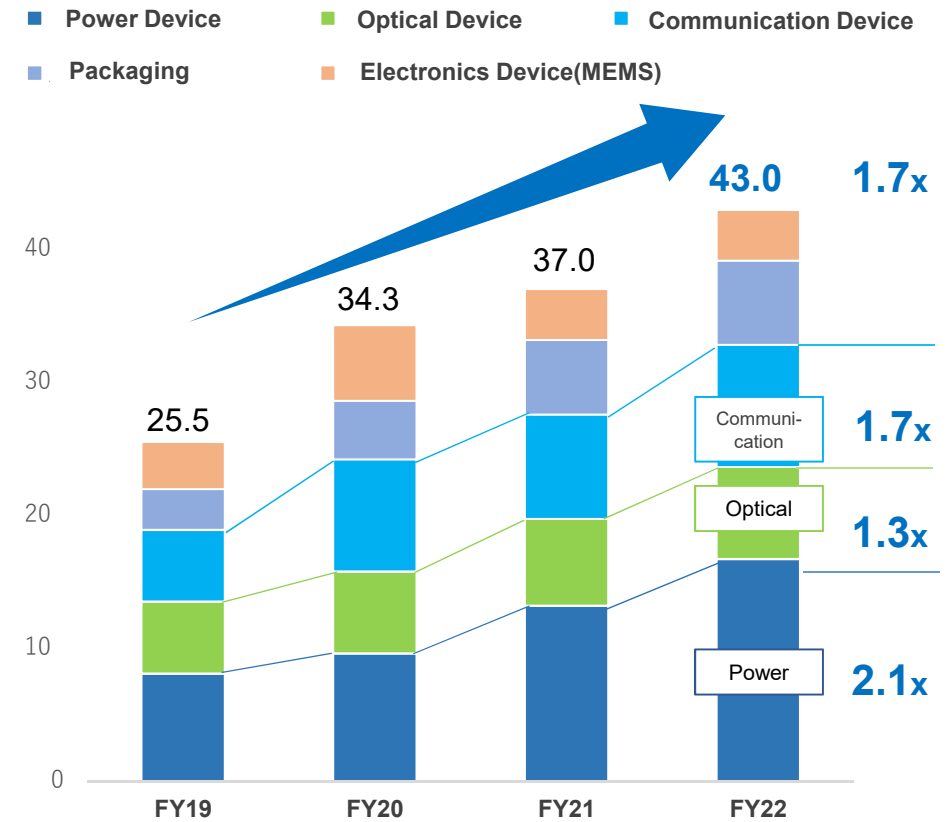
Multifunctionalization

- Expansion of electronic device-related investment in line with new energy shift and digital infrastructure investment
- Plan to grow 2.7 times compared to FY19 in China, partly due to the government's policy of domestic production
- Active investment in power devices, optical devices, communication devices, batteries, etc. (Battery belongs to FPD Department)

Order Plan (by area) (Unit: ¥1 billion)

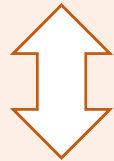


Order Plan (by segment) (Unit: ¥1 billion)



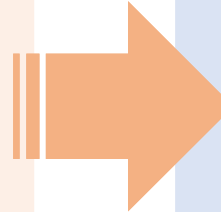
Growing Demand for Electronic Devices

- New energy shift
- Digital Infrastructure Construction



Large Electronic device market depending on imports

- World's factory (1.4 billion consumers)
- Electronic devices are mostly imported



Domestic Production Policy

- Stabilizing the supply chain (Avoid Procurement risk)
- Improvement of trade balance



Local government support, vigorous entrepreneurship

- Various preferential and supportive measures to attract businesses
- New entrants surging

New Energy Shift (Carbon Neutral)

- **Renewable Energy Shift**
Renewable energy expected to be majority in 2025
- **Increase in new energy vehicles**
1.36M units in 2020 ⇒ 8.75M units in 2025 (expectation)
- **Global LiB production volume**
65 billion RMB(46% produced by Chinese companies) in 2020
⇒ 120 billion RMB during 2025 to 2027

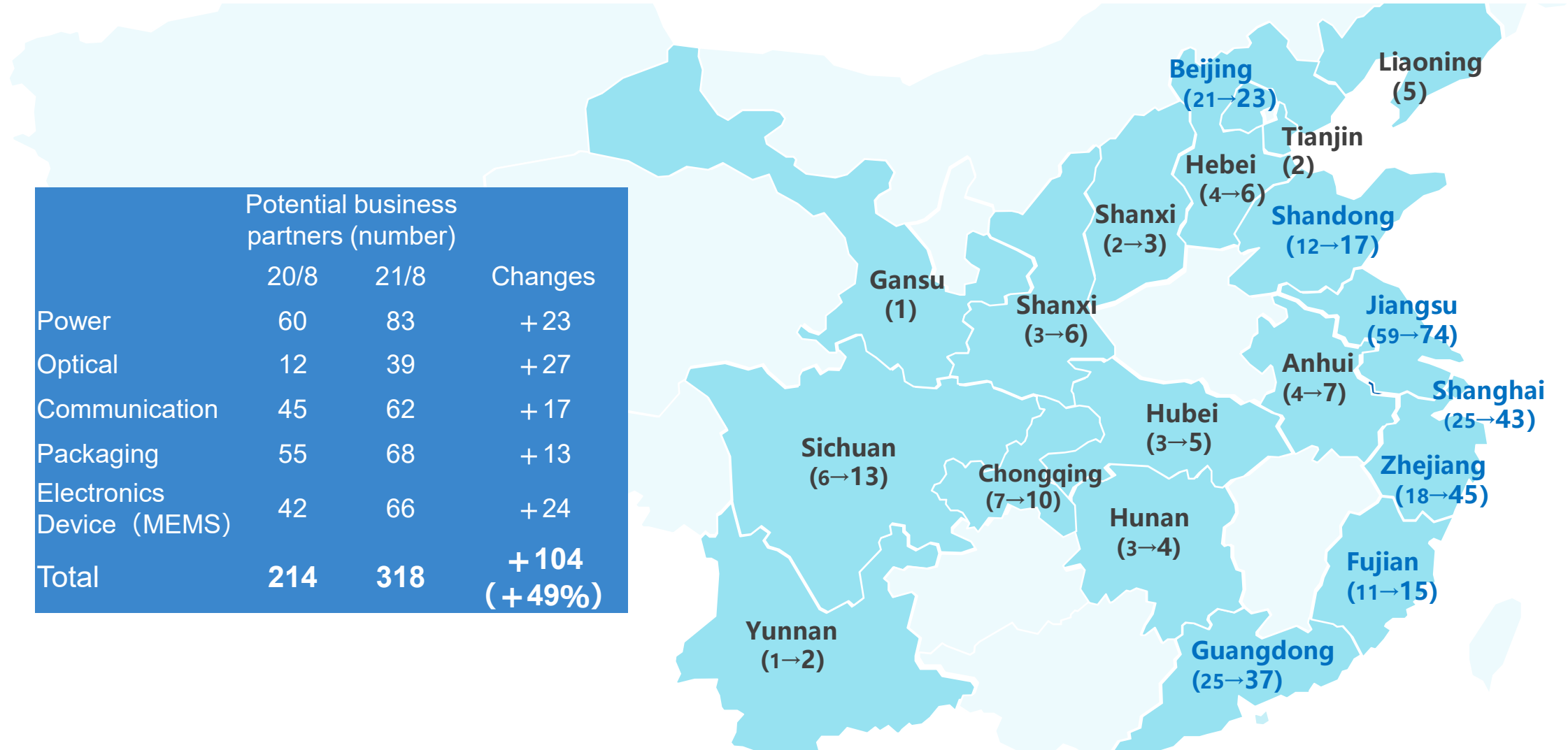
Digital Infrastructure Construction

- **5G base station**
1.3M bases in 2019 ⇒ 5.8M bases in 2026
- **Data Center Construction**
The amount introduced in a single year in 2025: 3 times more than 2020
- **Power Device Market**
4.8 billion RMB in 2020
⇒ 31.6 billion RMB in 2025
- **High-frequency device market (5G, etc.)**
In 2025 : 3.1 billion RMB(3 times)

Source : the document made by Mr. Noriyoshi Kuromasa, Shanghai Bureau Chief, Sangyo Times

Active electronics investment in China







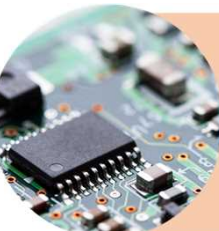

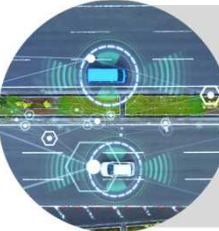

- The domestic production policy and the local government support stimulate investment in the electronics sector, especially in coastal areas.
- Business negotiations increased in a wide range of fields such as power device, optical-device, communication devices and packaging



	Potential business partners (number)		
	20/8	21/8	Changes
Power	60	83	+ 23
Optical	12	39	+ 27
Communication	45	62	+ 17
Packaging	55	68	+ 13
Electronics Device (MEMS)	42	66	+ 24
Total	214	318	+ 104 (+49%)

Ulvac's lineup of equipment for various electronic device fields and applications



	Final Usage	Device
 <p>Power Device</p>	<p>EV Automotive Devices Inverter Motors Industrial robots Power Saving Devices</p> 	<p>IGBT SiC Diodes MOSFET</p>
 <p>Optical Device</p>	<p>AR/VR Automotive instrument panels 3D Sensor</p> 	<p>μOLED Anti-reflection film Band Pass Filter</p>
 <p>Communication Device</p>	<p>Smartphones Wireless base stations</p> 	<p>SAW and BAW Filters RF Devices</p>
 <p>Packaging</p>	<p>PC Smartphones Data Servers IoT devices</p> 	<p>FanOut WFP•PLP Info-package</p>
 <p>Electronics Device (MEMS)</p>	<p>Fingerprint recognition LiDAR</p> 	<p>Piezo-MEMS</p>

ULVAC's Equipment



Sputtering Equipment



Evaporation Equipment



Ion Implanter



CVD Equipment



Etcher Equipment



Ashing Equipment

Integration of a wide range of fields and diverse technologies

(Equipment)
Sputtering
Evaporation
CVD
Ion Implanter
Etcher
etc.

Component

Materials

Customer Support

Strong Networks in East Asia

Wide customer base

Advanced research institutions network

Development, sales and CS base network

Manufacturing sites and supplier network

Ability to respond to technological innovation

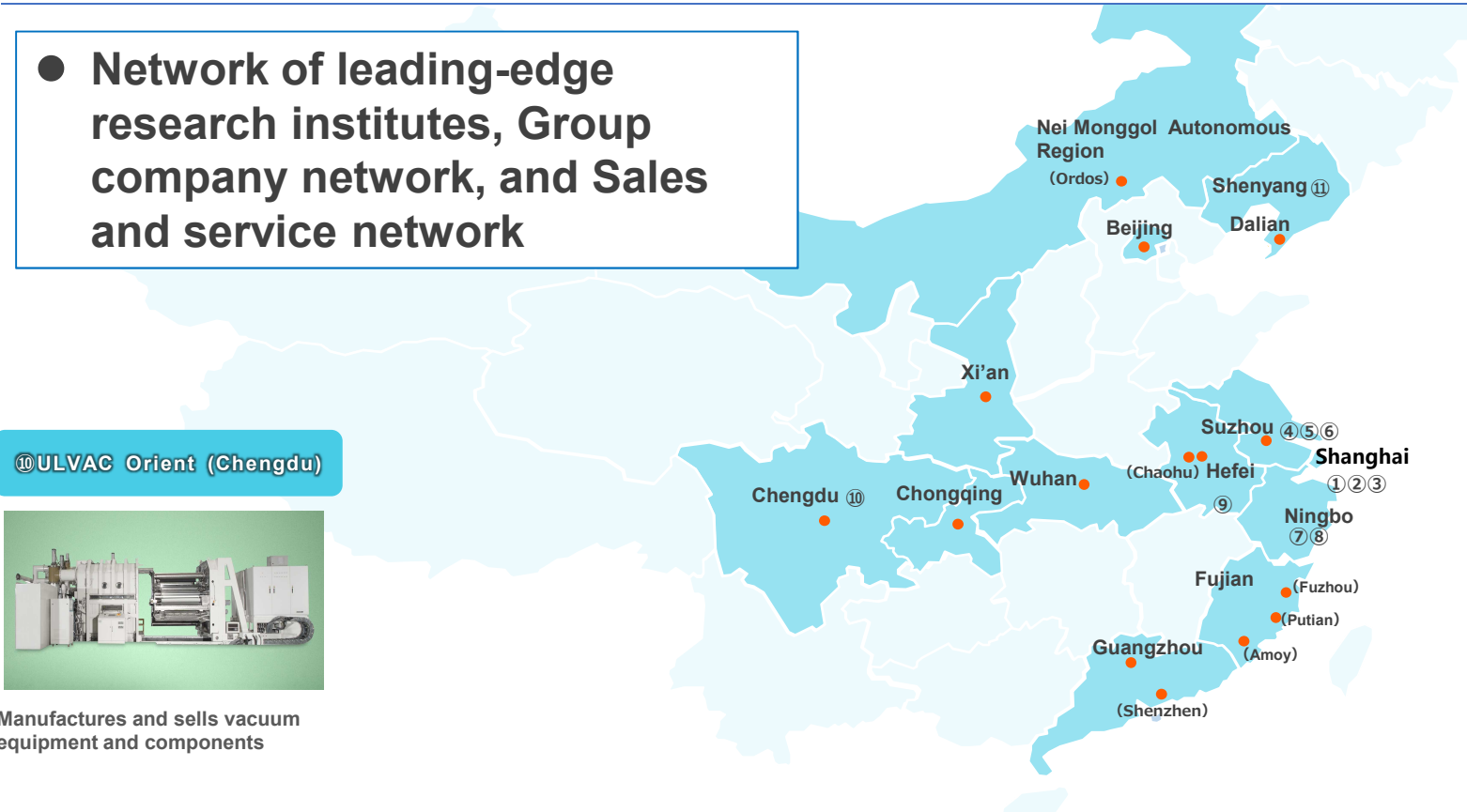
Vacuum Thin Film Processing Technology

Basic technology for equipment, processes, materials, etc.

Collaborating with the world's leading companies and advanced research institutions

Extensive Network in China

● Network of leading-edge research institutes, Group company network, and Sales and service network



⑪ ULVAC (Shenyang) CO.,LTD.



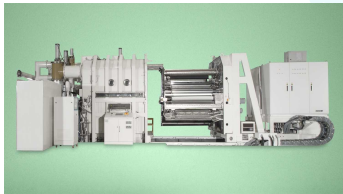
Manufactures, sells, and provides customer support for vacuum equipment

③ ULVAC Automation Technology (Shanghai)



Develops, designs, manufactures, and sells electrical control panel and automatic control solution

⑩ ULVAC Orient (Chengdu)



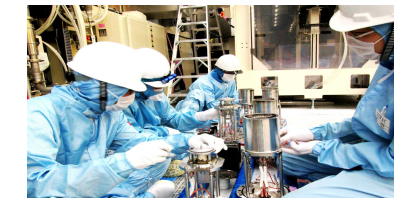
Manufactures and sells vacuum equipment and components

① ULVAC (CHINA) HOLDING



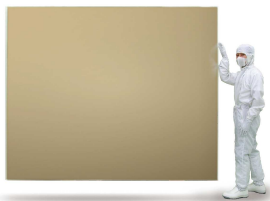
Undertakes administrative and coordinating tasks for investment and business in China

② ULVAC (Shanghai) Trading



Sells and provides customer support for products manufactured by ULVAC group companies
● Branch office or CS

⑨ ULVAC Coating Technology (H E F E I)



Manufactures, processes, and sells mask blanks for flat panel displays

⑧ ULVAC CRYOGENICS (N I N G B O)



Manufactures, sells, and provides customer support for cryopump

⑦ ULVAC (NINGBO) CO., LTD.



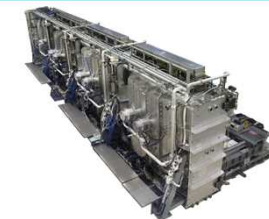
Manufactures and sells vacuum pumps

⑥ ULVAC Research Center SUZHOU Co., Ltd.



Provides technologies for R&D into vacuum equipment

⑤ ULVAC (SUZHOU) CO., LTD.



Manufactures and sells vacuum equipment and components

④ ULVAC Materials (Suzhou)



Develops, manufactures, sells, and provides customer support for sputtering targets

Ulvac's lineup of equipment for various electronic device fields and applications



	Final Usage	Device
<h2>Power Device</h2>	EV Automotive Devices Inverter Motors Industrial robots Power Saving Devices	IGBT SiC Diodes MOSFET
<h2>Optical Device</h2>	AR/VR Automotive instrument panels 3D Sensor	μ OLED Anti-reflection film Band Pass Filter
<h2>Communication Device</h2>	Smartphones Wireless base stations	SAW and BAW Filters RF Devices
<h2>Packaging</h2>	PC Smartphones Data Servers IoT devices	FanOut WFP•PLP Info-package
<h2>Electronics Device (MEMS)</h2>	Fingerprint recognition LiDAR	Piezo-MEMS

ULVAC's Equipment



Sputtering Equipment



Evaporation Equipment



Ion Implanter



CVD Equipment

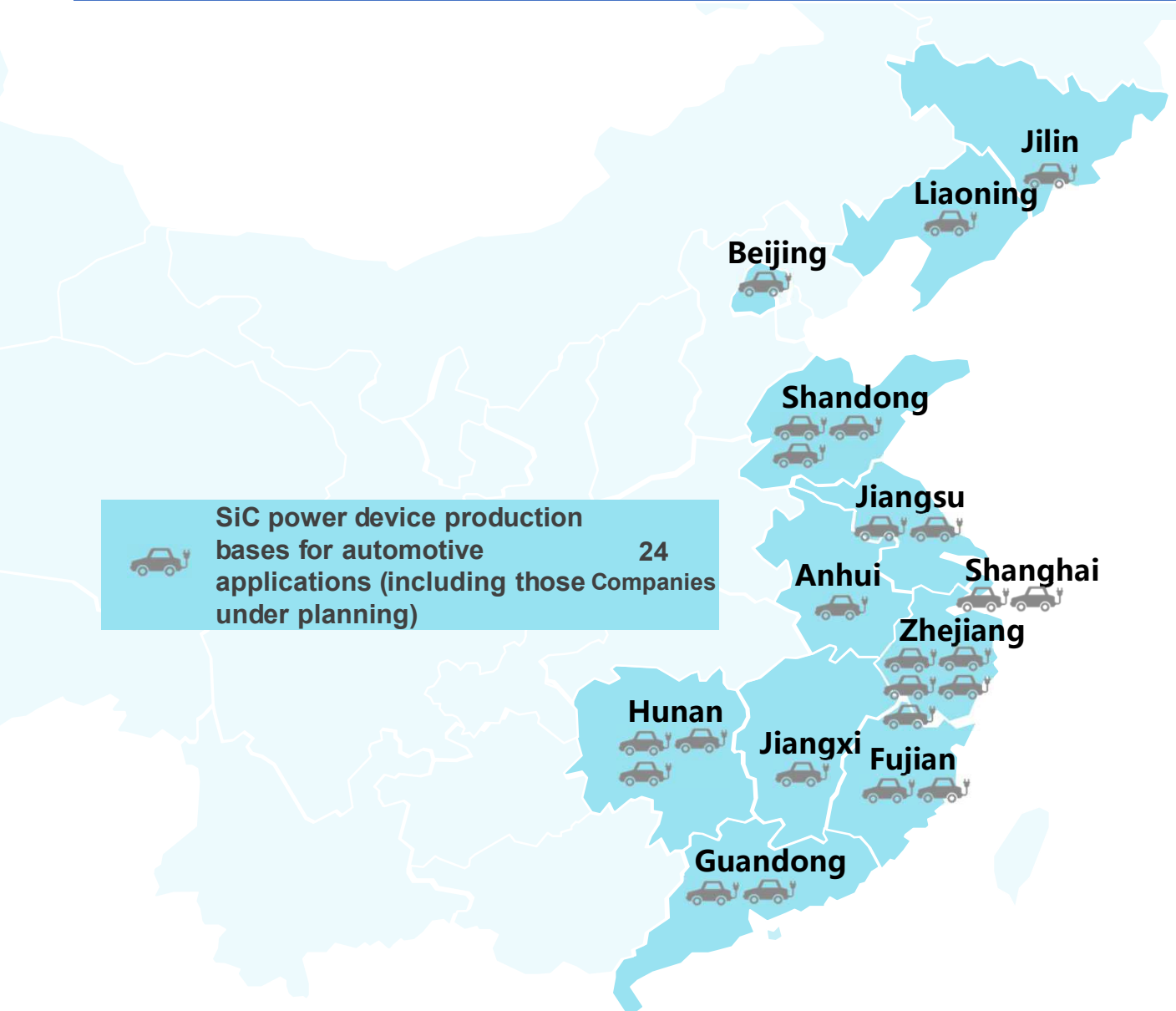


Etcher Equipment



Ashing Equipment

Investment in SiC Power Semiconductors for Automotive applications increasing in China **ULVAC**



- Increasing importance of high-power power devices due to the development of green energy and EVs

Market Environment

ULVAC's Equipment

IGBT

High voltage
Large current

- ✓ Active investment by major Japanese companies

Japanese Company	Investment Amount/Period
Company A	¥130 billion/5 years(2021-2026)
Company B	¥160 billion/4 years(2019-2023)
Company C	¥18.8 billion/3 years(2021-2023)
Company D	¥60 billion/5 years(2020-2025)



Backside Metallization Sputtering System

SiC

High voltage
Large current

- ✓ Accelerating green energy investment
- ✓ Domestic Production Policy and Local Government Support
- ✓ Strengthening SiC Wafer Production in China



Sputtering System



Etching System



Ion Implantation System



Evaporation System

Si-MOSFET

Low voltage
Small current

- ✓ Inverterization of home appliances, etc.
- ✓ Domestic production policy and local government support
- ✓ Strong demand for low to mid-end devices



Batch-type High Vacuum Evaporation System P.11

Background of SiC's Growth in China

- Increasing demand for power devices as the shifts to new energy (power generation, power transmission, power storage, EV, etc.) and the development of digital infrastructure
- Focus on power devices, as trade frictions between the U.S. and China makes it difficult to develop leading-edge semiconductors (large appetite for domestic production)
- Expectations for the possibility of replacing Si-IGBTs in automotive applications
- Enhancement of SiC supply chain
 - ✓ More than 24 SiC wafer factories (2.15 million wafers in total)
 - ✓ More than 35 SiC semiconductor construction projects

Features of Ion Implanters for SiC

- ✓ Ion implantation at high energy
- ✓ High temperature process treatment
- ✓ Implantation at different depths in several stages

Supporting mass production with Chinese companies for the past 10 years

More than 70% share of Chinese SiC ion implanter market



High-temp Ion Implanter for SiC
IH-860PSIC

Source: The presentation material made by Mr. Noriyoshi Kurosasa, Shanghai Bureau Chief, Sangyo Times

Si – MOSFET Market in China

- China procures about 40% of Si-MOSFETs as production goods
- Dependence on imports ⇒ Strong desire to produce domestically
- Increasing demand for EVs and 5G (smartphones and base stations) ⇒ Robust investment

Advantages of ULVAC's Vacuum Deposition Equipment

- High productivity and low-cost equipment through local production in China
- ✓ High quality equipment manufacturing technology
- ✓ Local design
- ✓ Supply chain development and construction

Company Profile

Company Name	ULVAC (SUZHOU) CO., LTD.
Establishment	July,2003
Employees Number	135 (as of 2021/6)
Product	FPD·Electronics Device Production Equipment

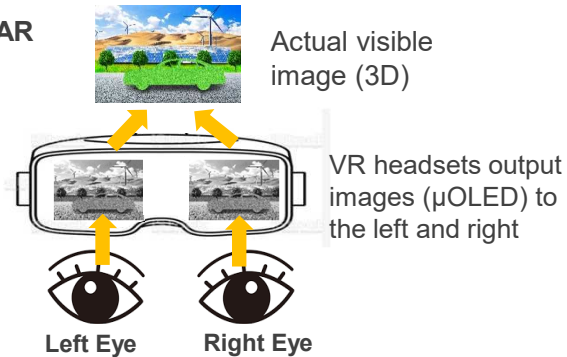


- Rapid expansion of various applications as the connected world advances

Usage · Structure

μOLED
for AR/VR

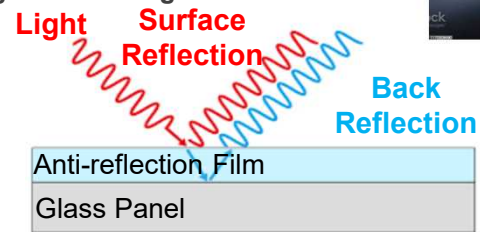
Structure of AR



Anti-Reflection Film
for automotive
instrument panels

Structure of Anti-reflection Film

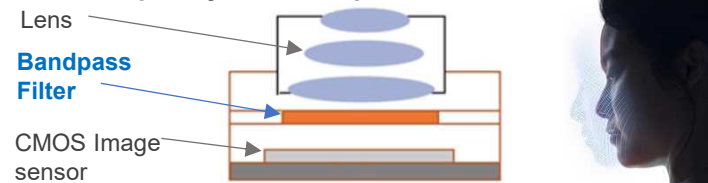
Reflection reduction by two wavelengths canceling each other out



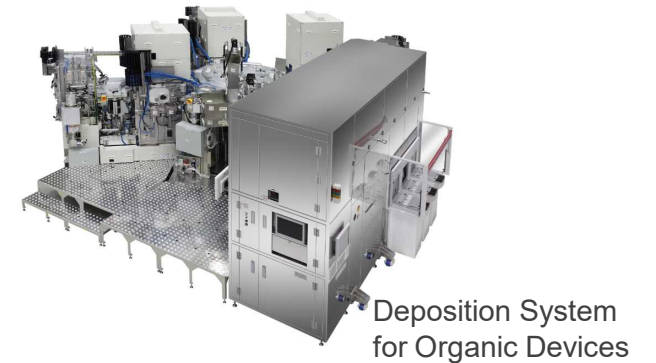
3D Sensor
for biometric
authentication,
etc.

Structure of Bandpass Filter

Filter for infrared cameras such as smartphones: only the desired frequency band can pass



ULVAC's Equipment



- As 5G and IoT become widespread, communication devices and MEMS will expand with technological innovation.

Market Environment

Higher Frequency SAW・BAW Filter

- ✓ Full-scale diffusion of 5G
- ✓ Technological innovation and new materials due to higher frequency
- ✓ Expansion of applications and increase in the number of installed devices

Base Station RF Device

- ✓ Full-scale diffusion of 5G
- ✓ Improvement of base station network
- ✓ Increase in high-speed, high-capacity communication devices

MEMS Piezo-MEMS etc.

- ✓ Development of 5G and IoT ⇒ Increasing number of sensors
- ✓ Higher performance, smaller size, lower power consumption
- ✓ Expansion of applications for sensors and actuators

ULVAC's Equipment



Combined modules' deposition system of cluster type



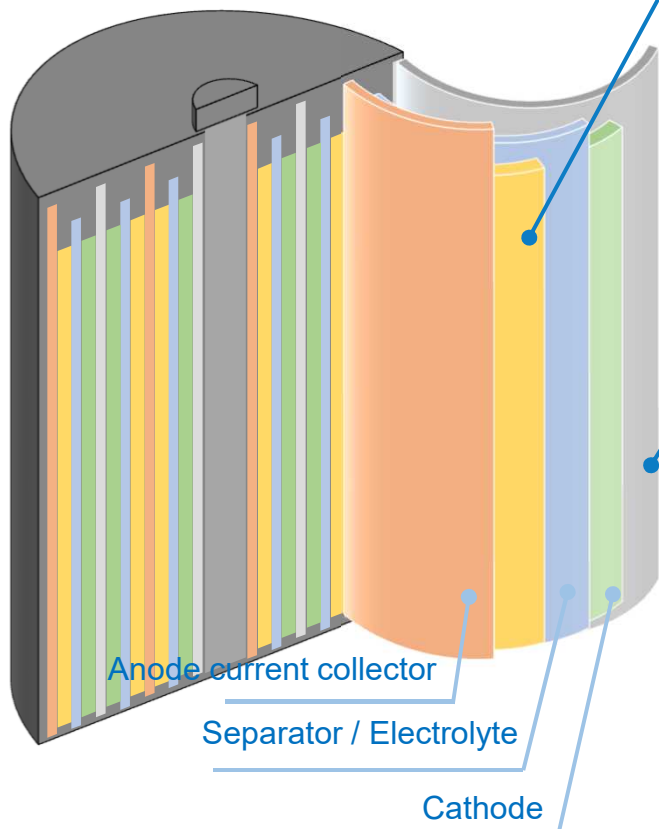
Dry Etching Tool



Cluster-type PE-CVD System

Battery Trends

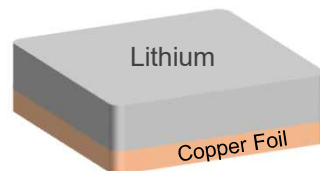
- ❑ High energy density
- ❑ Fast charging
- ❑ High safety
- ❑ Long life span



Trends in Battery Materials

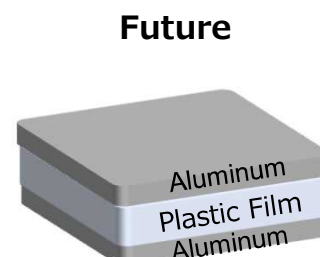
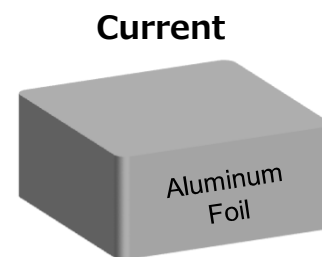
Anode

- ❑ Practical application of Li metal
- ❑ Increase in energy density
- ❑ Elimination of dead lithium and dendrites



Cathode Current Collector

- ❑ Reduction of weight and volume
- ❑ Improved strength
- ❑ Short circuit prevention



Product Development

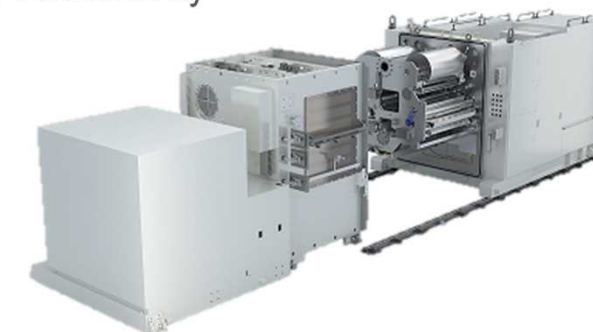
Li Evaporation Equipment

- ❑ Precise control of Li content
- ❑ High purity
- ❑ High smoothness



Al Evaporation Equipment

- ❑ Batch double-sided film deposition
- ❑ Low resistance
- ❑ High productivity

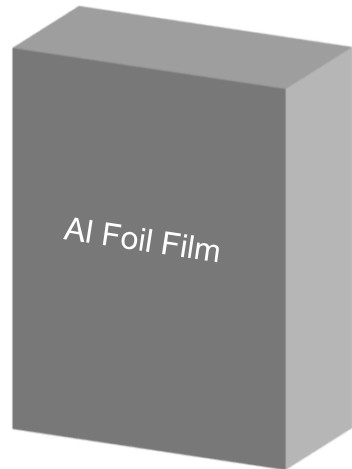


High Energy Density

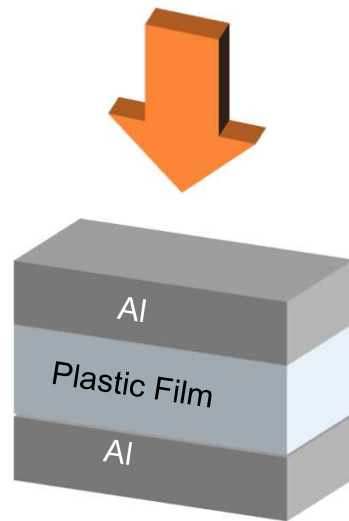
(Energy per volume Wh/l)

- ✓ The overall thickness is halved, and the volume is reduced
→ **Increase of Energy Density**

Existing Technology



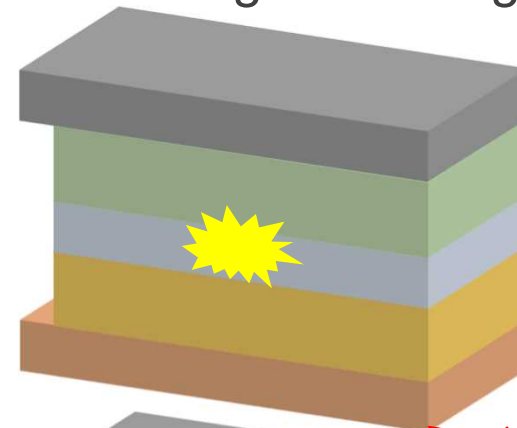
Al Foil Film



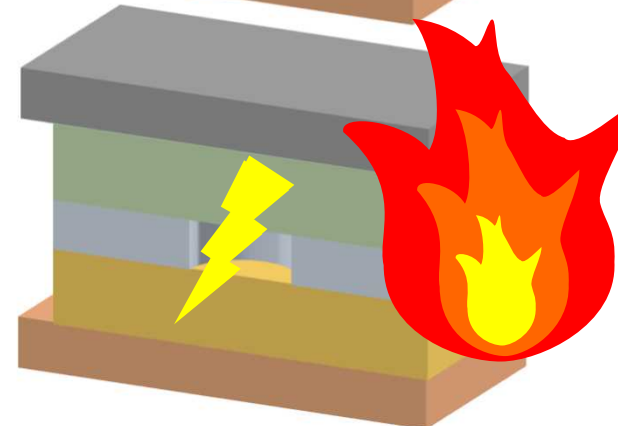
Safety

- ✓ **Prevention of short circuit** by burning out current collector film
→ **Prevention of Fire**
- ✓ **Material strength of plastic film is stronger than aluminum foil**
→ **Increase of Resistance**

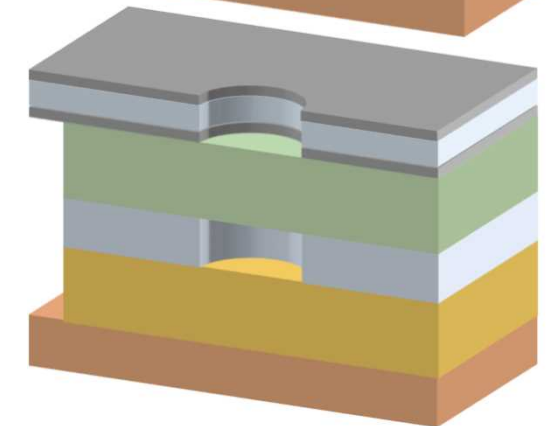
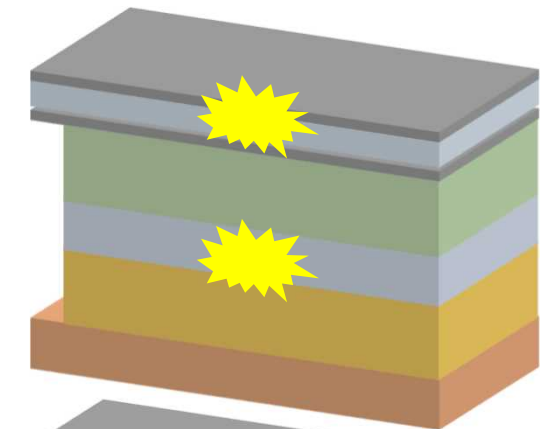
Existing Technology



Cathode current collector
Cathode
Separator
Anode
Anode current collector

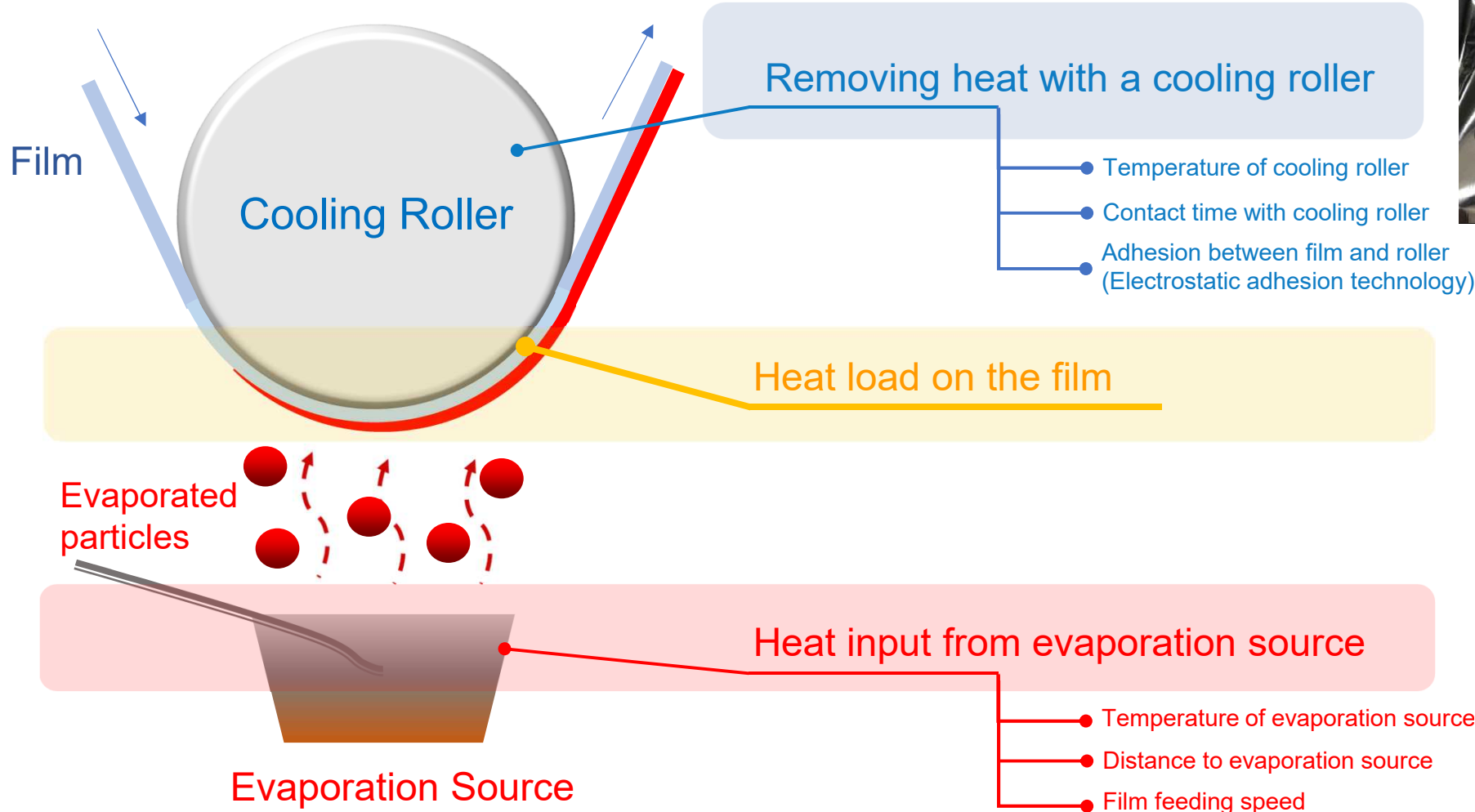


Al Foil Film



Advantages of Our Roll to Roll Equipment

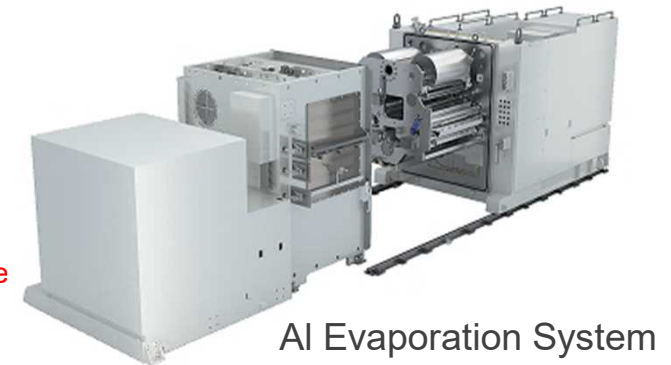
- ✓ Film formation while removing heat with a cooling roller
 - Prevention of thermal deformation, wrinkles, and tears in the film



Wrinkles and rips!



No damage to the film



Market Environment

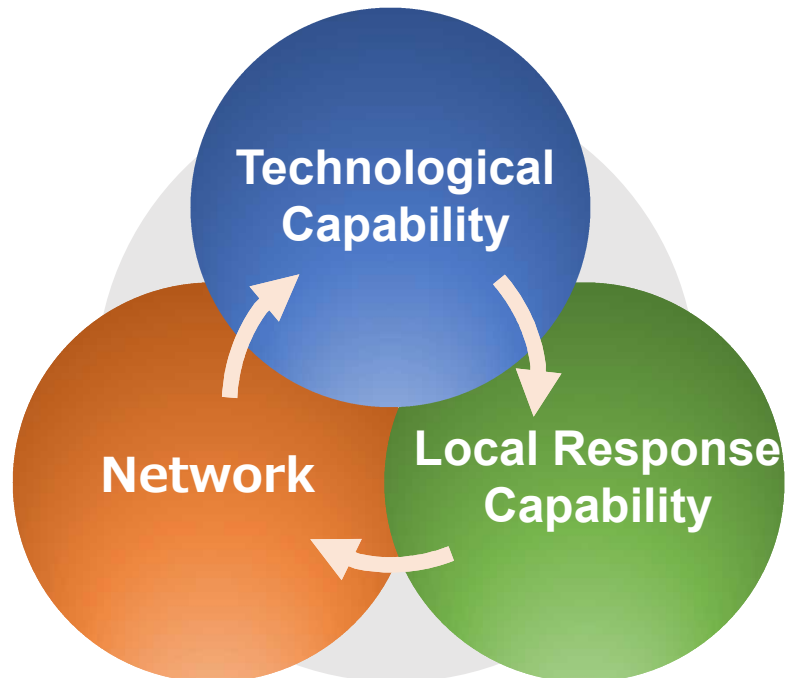
1 New Entry and Active Investment

- Domestic production policy and increasing demand
- Wide range of electronic device fields
- High-end to low-end
- Focus on speed

2 Needs of the Chinese Market

- Equipment with successful results
- Early start-up and mass production
- Approaches to cutting-edge technologies

ULVAC's Advantages



Technological Capability

- Equipment lineup for a variety of applications
- Extensive experience and high reliability in Japan
- Providing high performance, compact size, and energy-saving solutions

Local Response Capability

- Technological sales capabilities strengthened by dispatched engineers from Japan
- Localization of mass production models / Price competitiveness
- Sales /service base network and support system

Network

- Network of major leading-edge research institutes
- Cooperation with group companies (Japan, Korea, Taiwan)

Here to Seize the Moment



ULVAC Vacuum Technology Contributes to Many Industries and Applications



ULVAC